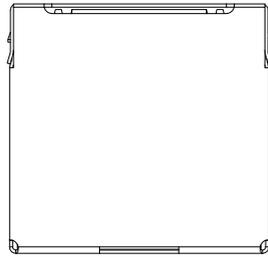
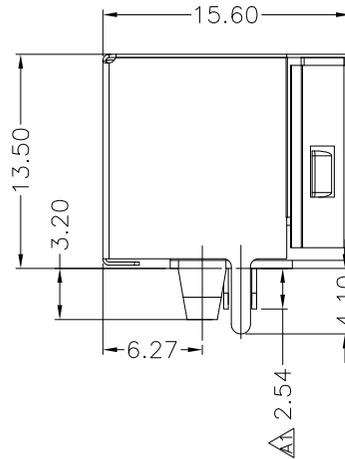
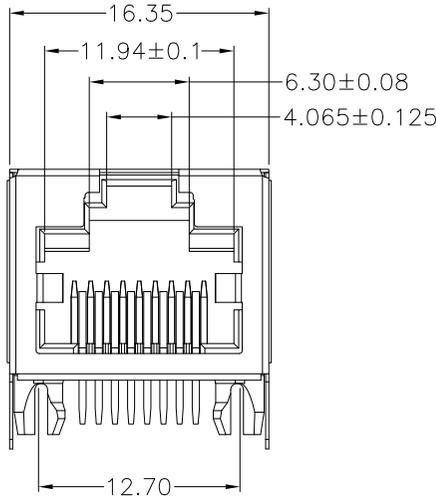
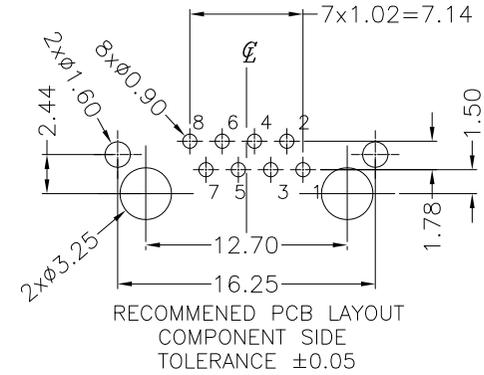


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2019/12/04	Phebe Su
A1			Change pin length to 2.54mm	2019/12/05	Phebe Su

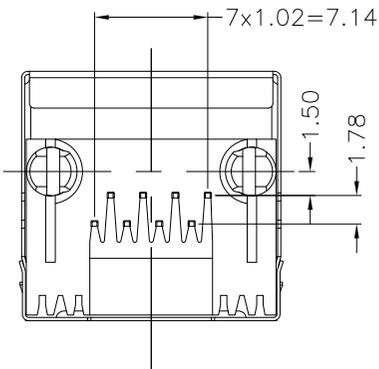


Printing :
YYWW

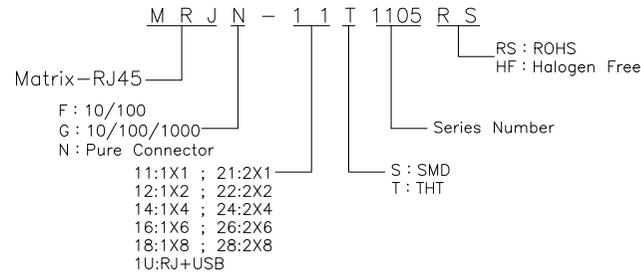


NOTES:

- MATERIALS:
HOUSING: PBT UL94V-0, BLACK.
CONTACTS: T=0.30 mm PHOSPHOR BRONZE, 50u" NICKEL UNDERPLATE 100u" TIN ON SOLDER TAIL
GOLD FLASH ON CONTACT AREA.
SHELL: STAINLESS T=0.20 NICKEL OVERALL
- OPERATING TEMPERATURE: -40°C ~ +85°C
- JACK CAVITY MEET IEC60603-7 AND FCC PART 68, SUBPART F



ORDER INFORMATION :



Matrix Electronics Co.,Ltd

TOLERANCE: X.X ±0.38 X.XX ±0.25 X.XXX ±0.13 ANGLE: ±3°	DESIGN BY : Phebe Su	DATE : 2019/12/05	PART NAME: RJ45 1x1 TAB UP PCB JACK	
APPROVED BY1: Richard Hsieh	DATE : 2019/12/05	PART NO.	MRJN-11T1105RS	
APPROVED BY2: Richard Hsieh	DATE : 2019/12/05	MOLD NO.	NA	
UNIT: mm [inch] SCALE:1:1 SIZE:A4		DRAW NO.	SHEET NO. 1 OF 1	